

7.62mm (0.3 INCH) SINGLE COLOR DOT MATRIX DISPLAY

Part Number: TC03-11SRT

Super Bright Red

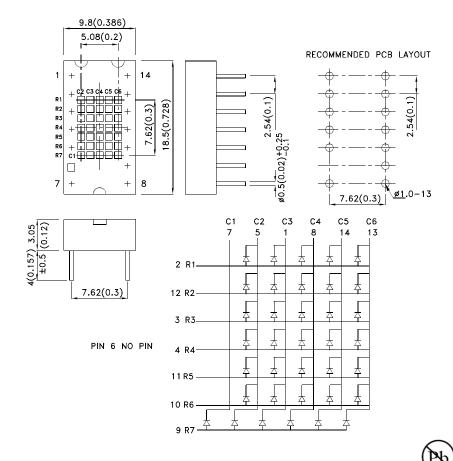
Features

- 0.3 inch matrix height.
- Low current operation.
- Stackable vertically and horizontally.
- Easy mounting on P.C. boards or sockets.
- Mechanically rugged.
- RoHS compliant.

Description

The Super Bright Red source color devices are made with Gallium Aluminum Arsenide Red Light Emitting Diode.

Package Dimensions& Internal Circuit Diagram



Notes:

1. All dimensions are in millimeters (inches), Tolerance is ±0.25(0.01")unless otherwise noted.

2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

SPEC NO: DSAN0592 REV NO: V.1A DATE: JUN/19/2013 PAGE: 1 OF 6
APPROVED: WYNEC CHECKED: Joe Lee DRAWN: Y.Liu

Selection Guide

Part No.	Dice	Lens Type	lv (ucd) [1] @ 10mA		Description
			Min.	Тур.	•
TC03-11SRT	Super Bright Red (GaAlAs)	Red Transparent	14000	30000	Column Cathode
			*3600	*7500	

Note:

Electrical / Optical Characteristics at TA=25°C

Lioution / Option Characteriotics at 171-20 C									
Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions			
λpeak	Peak Wavelength	Super Bright Red	655		nm	I=20mA			
λD [1]	Dominant Wavelength	Super Bright Red	640		nm	I=20mA			
Δλ1/2	Spectral Line Half-width	Super Bright Red	20		nm	IF=20mA			
С	Capacitance	Super Bright Red	45		pF	VF=0V;f=1MHz			
VF [2]	Forward Voltage	Super Bright Red	1.85	2.5	V	IF=20mA			
lr	Reverse Current	Super Bright Red		10	uA	V _R =5V			

- 1.Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

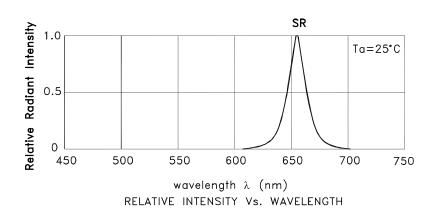
Parameter	Super Bright Red	Units		
Power dissipation	75	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	155	mA		
Reverse Voltage	5	V		
Operating / Storage Temperature	-40°C To +85°C			
Lead Solder Temperature[2]	older Temperature[2] 260°C For 3-5 Seconds			

- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
 2. 2mm below package base.

DATE: JUN/19/2013 SPEC NO: DSAN0592 **REV NO: V.1A** PAGE: 2 OF 6 APPROVED: WYNEC **CHECKED:** Joe Lee DRAWN: Y.Liu

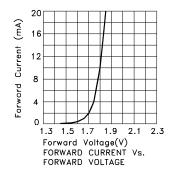
^{1.}Luminous intensity/ luminous Flux: +/-15%.

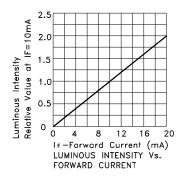
^{*}Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

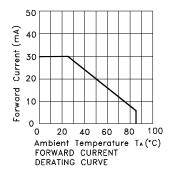


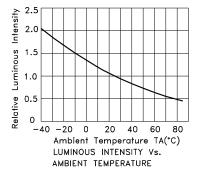
Super Bright Red

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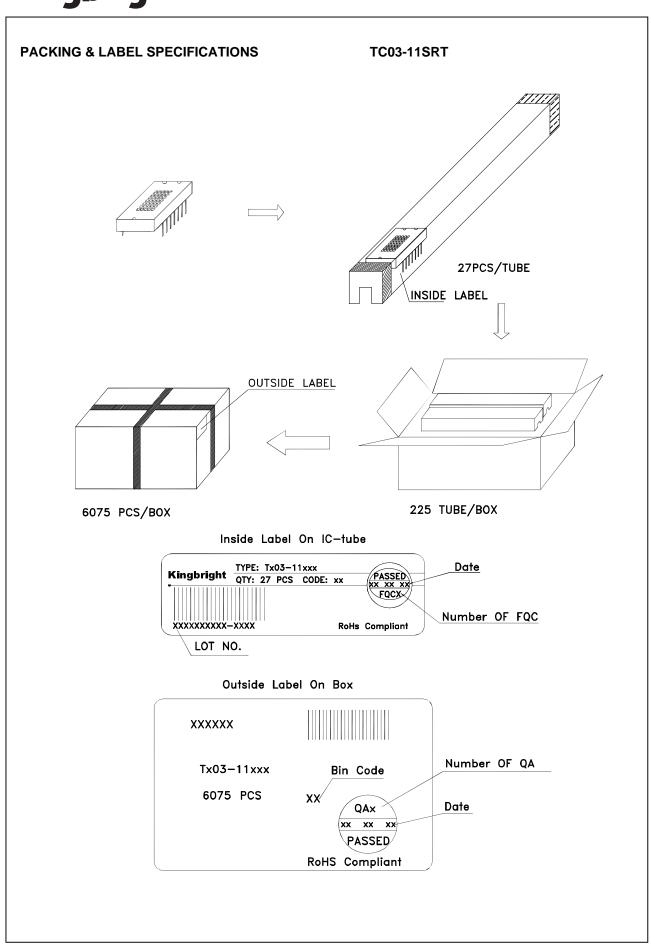








SPEC NO: DSAN0592 APPROVED: WYNEC REV NO: V.1A CHECKED: Joe Lee DATE: JUN/19/2013 DRAWN: Y.Liu PAGE: 3 OF 6

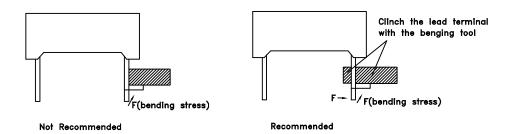


SPEC NO: DSAN0592 APPROVED: WYNEC REV NO: V.1A CHECKED: Joe Lee DATE: JUN/19/2013 DRAWN: Y.Liu PAGE: 4 OF 6

THROUGH HOLE DISPLAY MOUNTING METHOD

Lead Forming

Do not bend the component leads by hand without proper tools. The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.

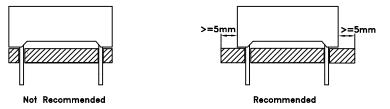


Installation

- 1. The installation process should not apply stress to the lead terminals.
- 2. When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.



3. The component shall be placed at least 5mm from edge of PCB to avoid damage caused excessive heat during wave soldering.

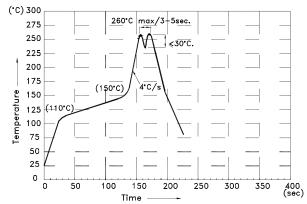


SPEC NO: DSAN0592 REV NO: V.1A DATE: JUN/19/2013 PAGE: 5 OF 6

APPROVED: WYNEC CHECKED: Joe Lee DRAWN: Y.Liu

DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

- 1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85°C.
- 3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.During wave soldering , the PCB top—surface temperature should be kept below 105°C

Soldering General Notes:

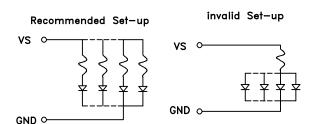
- 1. Through—hole displays are incompatible with reflow soldering.
- 2. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

CLEANING

- 1.Mild "no-clean" fluxes are recommended for use in soldering.
- 2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts .And the devices should not be washed for more than one minute.

CIRCUIT DESIGN NOTES

- 1.Protective current—limiting resistors may be necessary to operate the Displays.
- 2.LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.



DRAWN: Y.Liu

Detailed application notes are listed on our website. http://www.kingbright.com/application notes

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SPEC NO: DSAN0592 **REV NO: V.1A DATE: JUN/19/2013** PAGE: 6 OF 6 APPROVED: WYNEC